

App. No. 10/607,613
Amend. Dated 3/23/05
Response To Action dated 12/23/04

IPW



PATENT

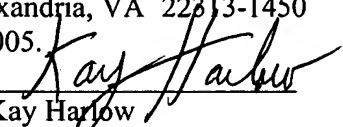
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of)
Kiermasz et al.) Examiner: Rachuba, Maurina T.
Application No: 10/607,613) Art Unit: 3723
Filed: June 27, 2003) Atty. Docket No: LAM2P421
For: PLATEN WITH DIAPHRAGM AND) Date: March 23, 2005
METHOD FOR OPTIMIZING WAFER)
POLISHING)
_____)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450 on March 23, 2005.

Signed


Kay Harlow

AMENDMENT AND RESPONSE

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Honorable Commissioner:

In response to the Office Action mailed December 23, 2004, which set a three month shortened period for response, please amend the captioned application and consider the following remarks.

Amendments to the claims start on page 2.

Remarks start on page 13.